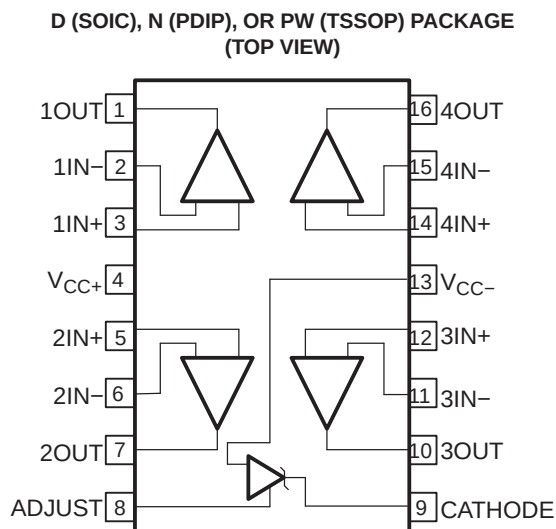


FEATURES

- **OPERATIONAL AMPLIFIER**
 - Low Offset Voltage, Max of:
 - TSM104WA...3 mV (25°C) and 4 mV (Full Temperature)
 - TSM104W...5 mV (25°C) and 6 mV (Full Temperature)
 - Low Supply Current...375 μ A/Channel Typ at $V_{CC} = 5$ V
 - Unity Gain Bandwidth...0.9 MHz Typ
 - Input Common-Mode Range Includes GND
 - Large Output-Voltage Swing...0 V to $V_{CC} - 2$ V
 - Wide Supply-Voltage Range...3 V to 30 V
 - 2-kV ESD Protection (HBM)
- **VOLTAGE REFERENCE**
 - Adjustable Output Voltage... V_{REF} to 36 V
 - $V_{REF} = 2.5$ V With Tight Tolerance, Max of:
 - TSM104WA...0.4% (25°C) and 0.8% (Full Temperature)
 - TSM104W...1% (25°C) and 2% (Full Temperature)
 - Low Temperature Drift...7 mV Typ Over Operating Temperature Range
 - Wide Sink-Current Range...0.5 mA Typ to 100 mA
 - Output Impedance...0.2 Ω Typ

TYPICAL APPLICATIONS

- Battery Chargers
- Switch-Mode Power Supplies
- Linear Voltage Regulation
- Data-Acquisition Systems



DESCRIPTION/ORDERING INFORMATION

The TSM104W combines the building blocks of a quad operational amplifier and an adjustable voltage reference, both of which often are used in the control circuitry of switch-mode power supplies.

For the A grade, especially tight voltage regulation can be achieved through the low offset voltage for each operational amplifier (typically 0.5 mV) and tight tolerance for the voltage reference (0.4% at 25°C and 0.8% over operating temperature range).

The TSM104W and TSM104WA are characterized for operation from –40°C to 105°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TSM104W, TSM104WA QUAD OPERATIONAL AMPLIFIER AND PROGRAMMABLE VOLTAGE REFERENCE

SLOS478D – JULY 2005 – REVISED AUGUST 2006

ORDERING INFORMATION

T_A	MAX V_{IO} AND V_{REF} TOLERANCE (25°C)	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 105°C	A grade 3 mV, 0.4%	PDIP – N	Tube of 25	TSM104WAIN	PREVIEW
		SOIC – D	Tube of 75	TSM104WAID	TSM104WAI
			Reel of 2500	TSM104WAIDR	
		TSSOP – PW	Tube of 75	TSM104WAIPW	SM104AI
			Reel of 2000	TSM104WAIPWR	
	Standard grade 5 mV, 1%	PDIP – N	Tube of 25	TSM104WIN	PREVIEW
		SOIC – D	Tube of 75	TSM104WID	TSM104WI
			Reel of 2500	TSM104WIDR	
		TSSOP – PW	Tube of 75	TSM104WIPW	SM104I
			Reel of 2000	TSM104WIPWR	

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Absolute Maximum Ratings⁽¹⁾

over free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{CC}	Supply voltage		36	V
V_{ID}	Operational amplifier input differential voltage		36	V
V_I	Operational amplifier input voltage range	–0.3	36	V
I_{KA}	Voltage reference cathode current		100	mA
θ_{JA}	Package thermal impedance ⁽²⁾⁽³⁾	D package	73	°C/W
		N package	67	
		PW package	108	
T_J	Maximum junction temperature		150	°C
T_{stg}	Storage temperature range	–65	150	°C

- (1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Selecting the maximum of 150°C can affect reliability.
- (3) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions

		MIN	MAX	UNIT
$V_{CC+} - V_{CC-}$	Supply voltage	3	30	V
I_K	Cathode current	1	100	mA
T_A	Operating free-air temperature	–40	105	°C

Total Device Electrical Characteristics

PARAMETER		TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT
I _{CC}	Total supply current, excluding cathode-current reference	V _{CC+} = 5 V, No load	Full range	1.4	2.4	4	mA
		V _{CC+} = 30 V, No load					

Operational Amplifier Electrical Characteristics

V_{CC+} = 5 V, V_{CC-} = GND, V_O = 1.4 V, T_A = 25°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT
V _{IO}	Input offset voltage	TSM104W	25°C	1		5	mV
			Full range			6	
		TSM104WA	25°C	0.5		3	
			Full range			4	
αV _{IO}	Input offset voltage drift		25°C	7			μV/°C
I _{IO}	Input offset current		25°C	2		30	nA
			Full range			50	
I _{IB}	Input bias current		25°C	30		150	nA
			Full range			200	
A _{VD}	Large-signal voltage gain	V _{CC+} = 15 V, R _L = 2 kΩ, V _O = 1.4 V to 11.4 V	25°C	50	100		V/mV
			Full range	25			
k _{SVR}	Supply-voltage rejection ratio	V _{CC+} = 5 V to 30 V	25°C	65	100		dB
V _{ICR}	Input common-mode voltage range	V _{CC+} = 30 V ⁽¹⁾	25°C	0	V _{CC+} – 1.5		V
			Full range	0	V _{CC+} – 2		
CMRR	Common-mode rejection ratio		25°C	70	85		dB
			Full range	60			
I _{source}	Output source current	V _{CC+} = 15 V, V _O = 2 V, V _{id} = 1 V	25°C	20	40		mA
I _{SC}	Short circuit to GND	V _{CC+} = 15 V	25°C	40		60	mA
I _{sink}	Output sink current	V _{CC+} = 15 V, V _O = 2 V, V _{id} = –1 V	25°C	10	20		mA
V _{OH}	High-level output voltage	V _{CC+} = 30 V, R _L = 10 kΩ	25°C	27	28		V
			Full range	27			
V _{OL}	Low-level output voltage	R _L = 10 kΩ	25°C	5		20	mV
			Full range			20	
SR	Slew rate at unity gain	V _{CC+} = 15 V, C _L = 100 pF, R _L = 2 kΩ, V _I = 0.5 V to 3 V, unity gain	25°C	0.1	0.3		V/μs
GBW	Gain bandwidth product	V _{CC+} = 30 V, V _I = 10 mV, C _L = 100 pF, R _L = 2 kΩ, f = 100 kHz	25°C	0.5	0.9		MHz
THD	Total harmonic distortion	V _{CC+} = 30 V, V _O = 2 V _{pp} , C _L = 100 pF, R _L = 2 kΩ, f = 1 kHz, A _V = 20 dB	25°C	0.01			%
V _n	Equivalent input noise voltage	V _{CC} = 30 V, R _S = 100 Ω, f = 1 kHz	25°C	25			nV/√Hz
Channel separation		1 kHz < f < 20 kHz	25°C	120			dB

(1) The input common-mode voltage of either input should not be allowed to go below –0.3 V. The upper end of the common-mode voltage range is V_{CC+} – 1.5 V, but either input can go to V_{CC+} + 0.3 V without damage (absolute maximum ratings still must be observed).

TSM104W, TSM104WA

QUAD OPERATIONAL AMPLIFIER

AND PROGRAMMABLE VOLTAGE REFERENCE

SLOS478D – JULY 2005 – REVISED AUGUST 2006

Voltage Reference Electrical Characteristics

PARAMETER		TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT
V _{REF}	Reference voltage	TSM104W I _K = 10 mA	25°C	2.475	2.5	2.525	V
			Full range	2.45		2.55	
	TSM104WA	I _K = 10 mA	25°C	2.49	2.5	2.51	
			Full range	2.48		2.52	
ΔV _{REF}	Reference input voltage deviation over temperature range	V _{KA} = V _{REF} , I _K = 10 mA	Full range		7	30	mV
$\frac{\Delta V_{REF}}{\Delta V_{KA}}$	Ratio of change in reference voltage to change in cathode voltage	V _{KA} = 3 V to 36 V, I _K = 10 mA	25°C	–2	–1.1		mV/V
I _{REF}	Reference input current	I _K = 10 mA	25°C		1.5	2.5	μA
			Full range			3	
ΔI _{REF}	Reference input current deviation over temperature range		Full range		0.8	1.2	μA
I _{min}	Minimum cathode current for regulation	V _{KA} = V _{REF}	25°C		0.5	1	mA
I _{K,OFF}	Off-state cathode current		25°C		180	500	nA
z _{ka}	Dynamic impedance ⁽¹⁾	V _{KA} = V _{REF} , f < 1 kHz, ΔI _K = 1 mA to 100 mA	25°C		0.2	0.5	Ω

(1) The dynamic impedance is defined as $|z_{ka}| = \frac{\Delta V_{KA}}{\Delta I_K}$.

TYPICAL OPERATING CHARACTERISTICS

$T_A = 25^\circ\text{C}$ (unless otherwise noted)

TOTAL HARMONIC DISTORTION (THD)
VS
FREQUENCY

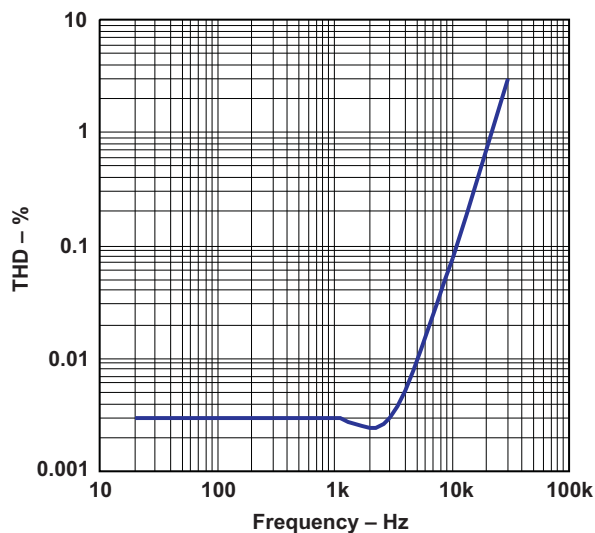


Figure 1.

AMPLIFIER NOISE VOLTAGE
VS
FREQUENCY

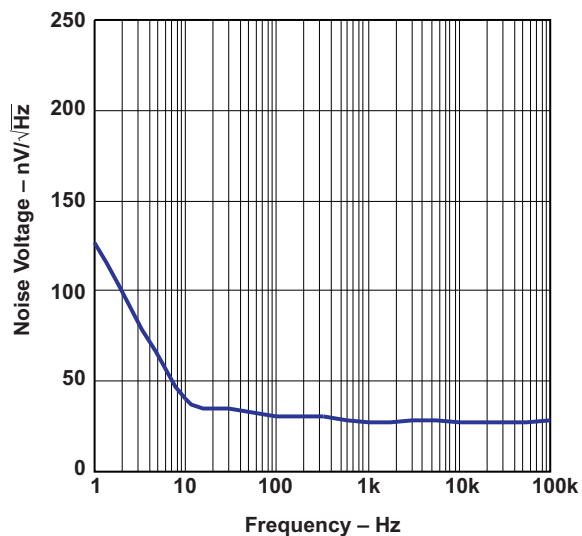


Figure 2.

I_K
VS
 V_{REF}

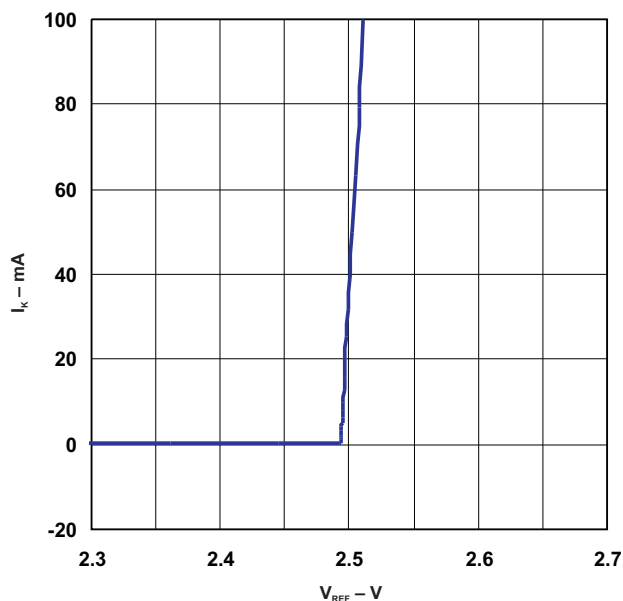


Figure 3.

V_{REF} STABILITY
VS
CAPACITANCE

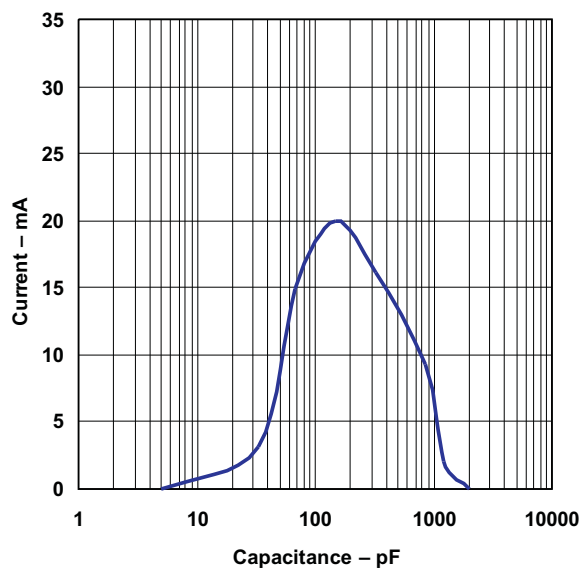


Figure 4.

TYPICAL OPERATING CHARACTERISTICS (continued)

$T_A = 25^\circ\text{C}$ (unless otherwise noted)

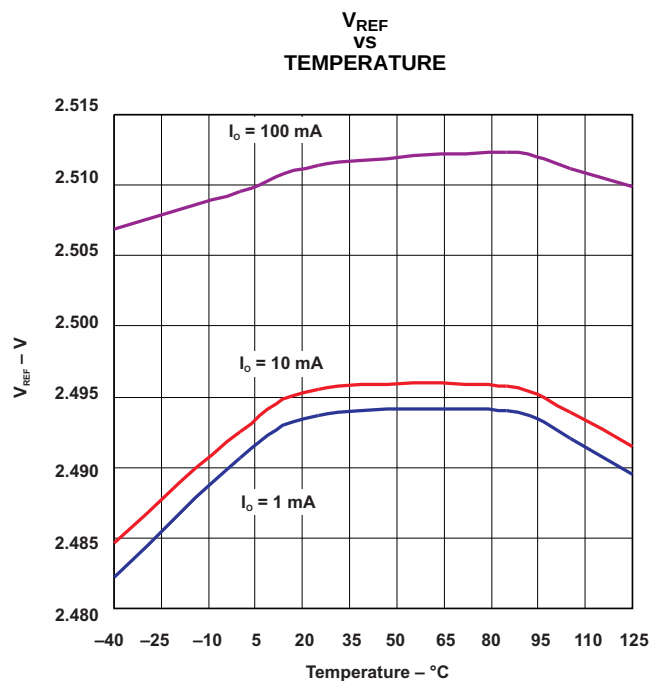


Figure 5.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TSM104WAID	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WAI
TSM104WAID.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WAI
TSM104WAIDR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WAI
TSM104WAIDR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WAI
TSM104WAIPWR	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	SM104AI
TSM104WAIPWR.A	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	SM104AI
TSM104WIDR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WI
TSM104WIDR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WI
TSM104WIPWR	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	SM104I
TSM104WIPWR.A	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	SM104I

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

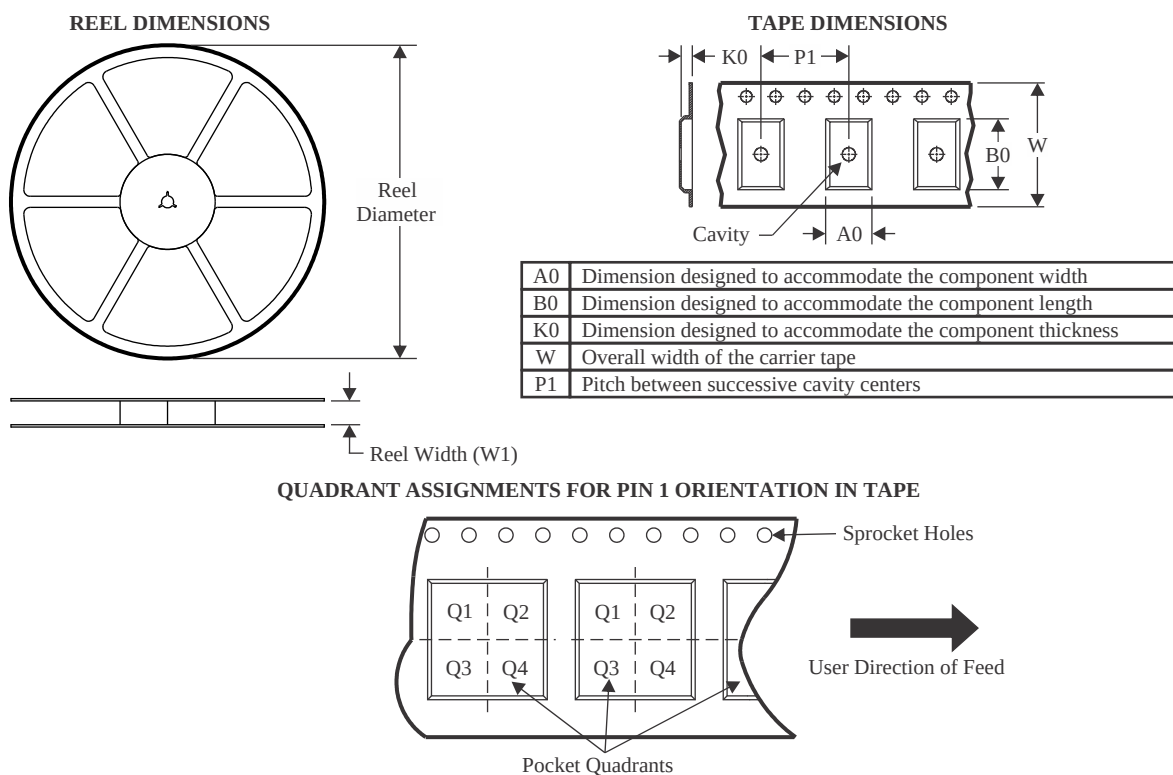
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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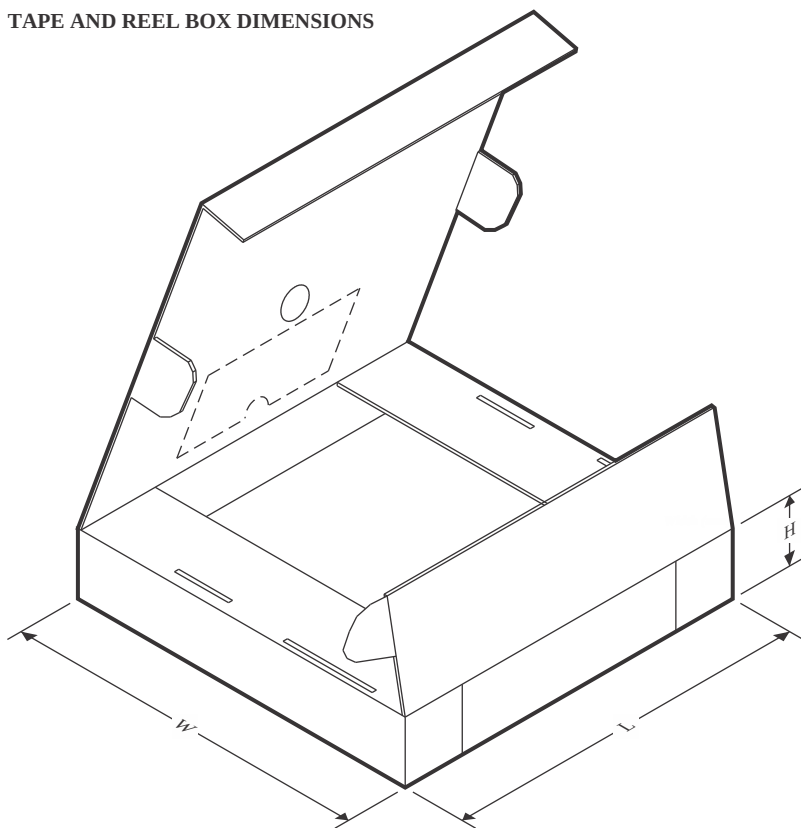
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TSM104WAIDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
TSM104WAIPWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TSM104WIDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
TSM104WIPWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

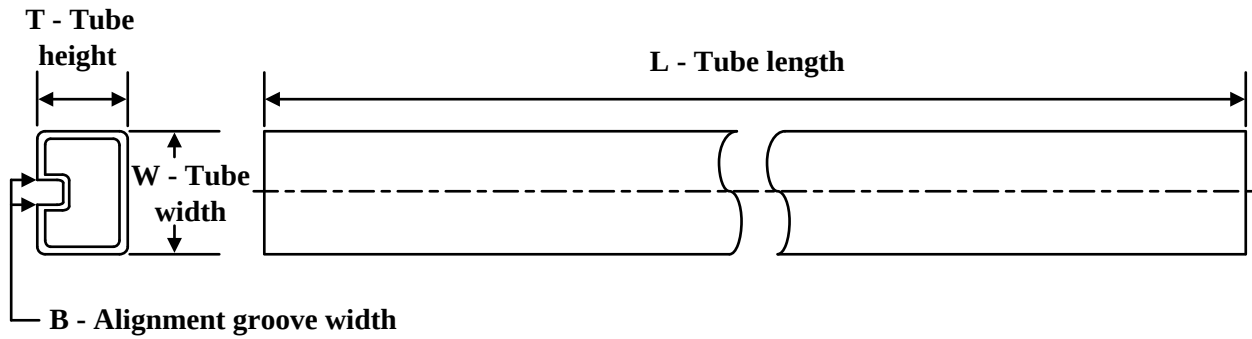
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TSM104WAIDR	SOIC	D	16	2500	353.0	353.0	32.0
TSM104WAIPWR	TSSOP	PW	16	2000	353.0	353.0	32.0
TSM104WIDR	SOIC	D	16	2500	353.0	353.0	32.0
TSM104WIPWR	TSSOP	PW	16	2000	353.0	353.0	32.0

TUBE

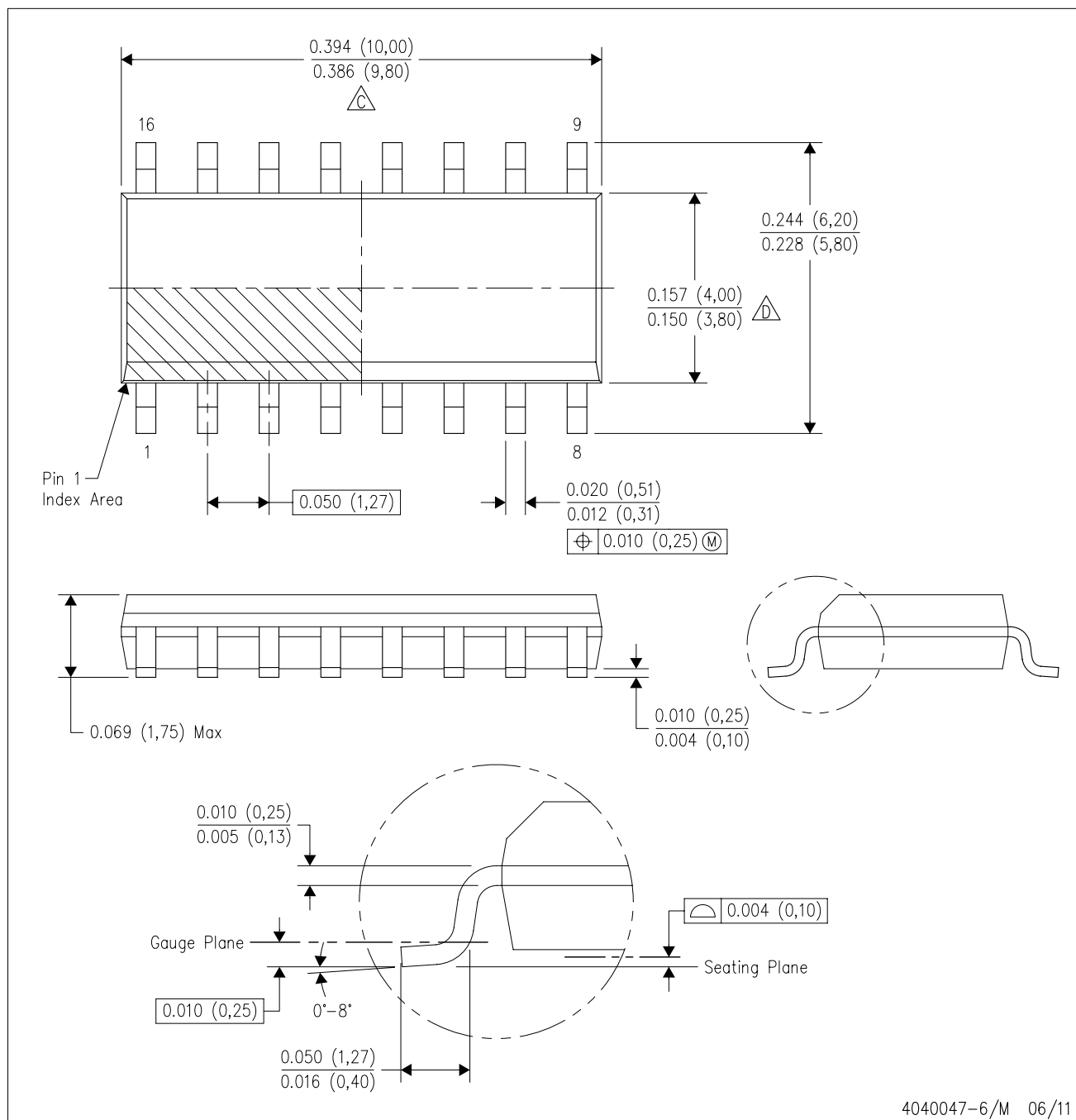


*All dimensions are nominal

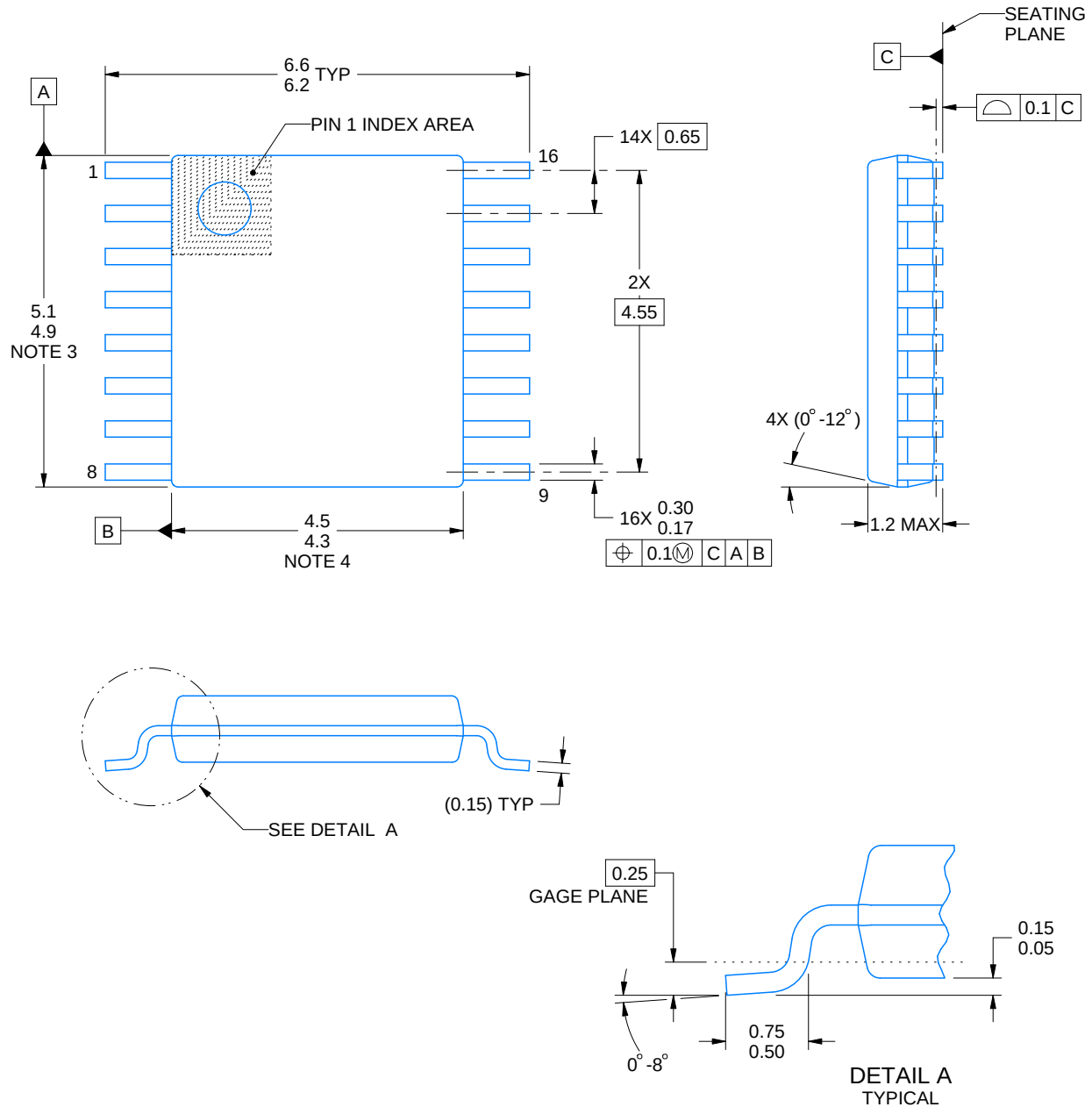
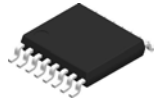
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
TSM104WAID	D	SOIC	16	40	506.6	8	3940	4.32
TSM104WAID.A	D	SOIC	16	40	506.6	8	3940	4.32

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - $\triangle D$ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.



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NOTES:

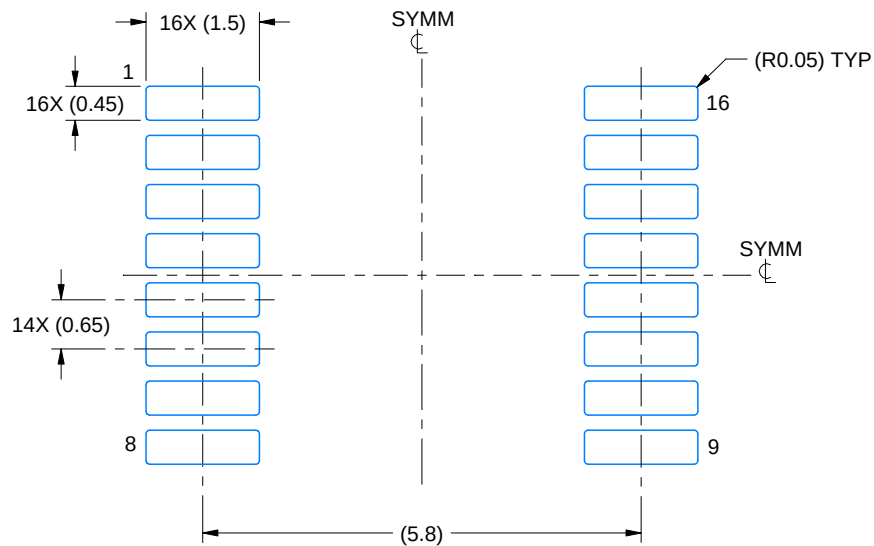
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

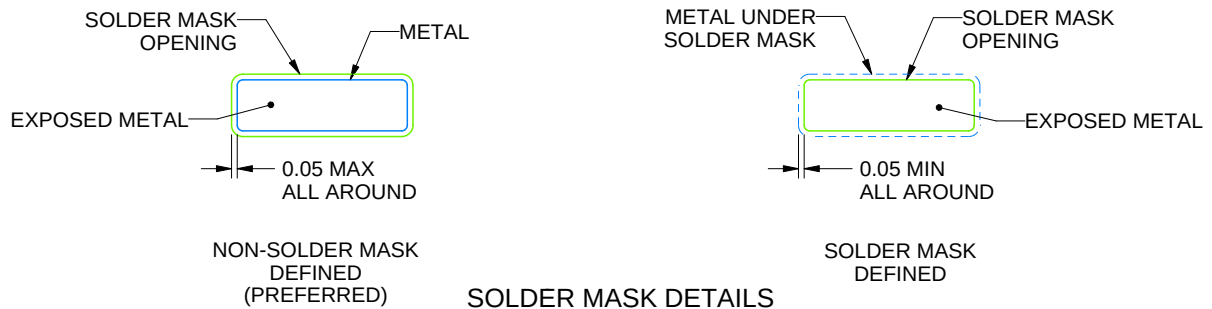
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

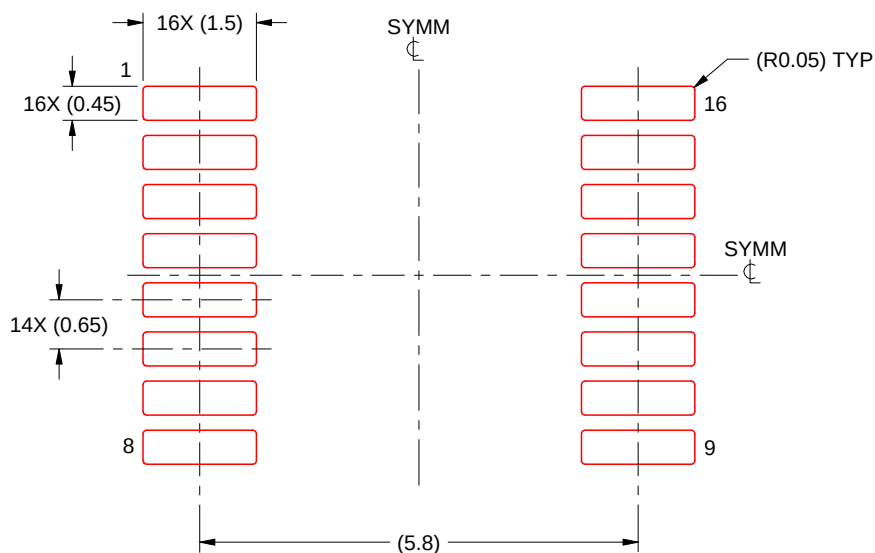
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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